



GP-1104

PATENT
Docket No. 420099-654
LSI Ref. P-2880/1D

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Cheryle A. Healion
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Mike Liang

Serial No.: 08/909,312

Filed: August 14, 1997

Entitled: **METHOD FOR
DISTRIBUTING CONNECTION PADS
ON A SEMICONDUCTOR DIE
(As Amended)**

Group Art Unit: 1104

Examiner:

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Assistant Commissioner for Patents
Washington, D.C. 20231

INFORMATION DISCLOSURE STATEMENT

Sir:

Submitted herewith are one sheet of Form PTO-1449 and one copy of each of the patent documents listed therein for the above-captioned divisional application.

It is respectfully requested that the Examiner make his consideration of each of these documents formally of record with his initial action.

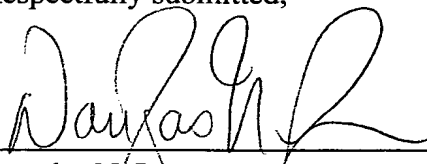
PATENT

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If any fees are due with this Information Disclosure Statement, the Commissioner is authorized to charge them to Deposit Account Number 16-2230.

Respectfully submitted,



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Dated: January 14, 1998

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